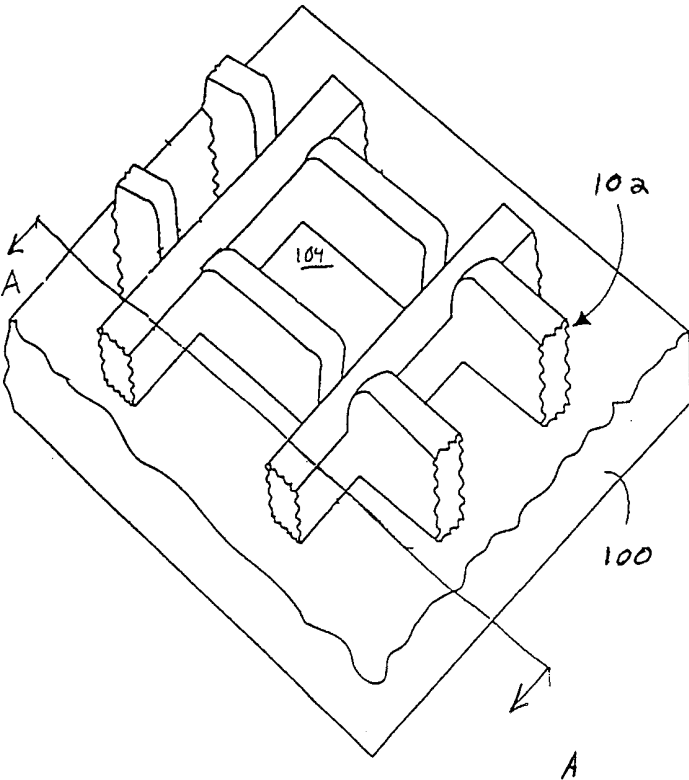




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(21) International Application Number: PCT/US99/10302 (22) International Filing Date: 11 May 1999 (11.05.99) (30) Priority Data: 09/126,701 30 July 1998 (30.07.98) US (71) Applicant: CANDESCENT TECHNOLOGIES CORPORATION [US/US]; 6580 Via Del Oro, San Jose, CA 95119 (US). (72) Inventors: PAN, Lawrence, S.; 313 Trenton Circle, Pleasanton, CA 94556 (US). STANNERS, Colin, D.; 1186 Shasta Avenue, San Jose, CA 95126 (US). FAHLEN, Theodore, S.; 6131 Corte De Reina, San Jose, CA 95120 (US). (74) Agents: GALLENSON, Mavis, S. et al.; Ladas & Parry, Suite 2100, 5670 Wilshire Boulevard, Los Angeles, CA 90036-5679 (US).		(81) Designated States: JP, KR, European patent (AT, BE, CH, CY, DE, DK, ES, FI, FR, GB, GR, IE, IT, LU, MC, NL, PT, SE). Published <i>With international search report.</i>
(54) Title: DECONTAMINATED COMPONENT OF A FLAT PANEL DISPLAY AND METHOD FOR SAID DECONTAMINATION		
(57) Abstract <p>A flat panel display that has internal components (102) that are cleaned using a dry cleaning treatment.</p> 		

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DECONTAMINATED COMPONENT OF A FLAT PANEL DISPLAY AND METHOD
FOR SAID DECONTAMINATION

5 FIELD OF THE INVENTION

The present claimed invention relates to the field of flat panel displays. More particularly, the present claimed invention relates to the internal components of a flat panel display.

10

BACKGROUND ART

Prior art flat panel displays include a backplate that includes a matrix structure of rows and columns of electrodes. One such flat panel display is described in U.S. Patent No. 15 5,541,473 titled GRID ADDRESSED FIELD EMISSION CATHODE that is incorporated herein by reference as background material. Typically, the backplate is formed by depositing a cathode structure (electron emitting) on a glass plate. The cathode structure includes emitters that generate electrons. The 20 backplate typically has an active area within which the cathode structure is deposited. Typically, the active area does not cover the entire surface of the glass plate, leaving a thin strip that extends around the glass plate. Electrically conductive traces extend through the thin strip to allow for 25 connectivity to the active area.

Prior art flat panel displays include a thin glass faceplate having one or more layers of phosphor deposited over the interior surface thereof. The faceplate is typically separated from the backplate by about 1 to 2 millimeters. The
5 faceplate includes an active area within which the layer (or layers) of phosphor is deposited. The faceplate is attached to the backplate using a glass seal that extends around the active areas of the faceplate and the backplate.

10 Sub-pixel regions on the faceplate of a flat panel display are typically separated by an opaque mesh-like structure commonly referred to as a matrix or "black matrix." By separating sub-pixel regions, the black matrix prevents electrons directed at one sub-pixel from overlapping another
15 sub-pixel. In so doing, a conventional black matrix helps maintain color purity in a flat panel display. Polyimide material is commonly used to form the black matrix. In addition, if the black matrix is three dimensional (i.e. it extends above the level of the light emitting phosphors), then
20 the black matrix can prevent some of the electrons back scattered from the phosphors of one sub-pixel from impinging on another, thereby improving color purity.

A support structure extends between the faceplate and the
25 backplate. This support structure overlies the black matrix and assures uniform spacing between the faceplate and the backplate. The support structure is typically formed of ceramic material.

The support structure may be walls, pins, or any of a number of other shapes.

- 5 A focusing structure that is formed over the active area of the backplate directs electron emission from the cathode. More particularly, the focusing structure is formed within the active area of the cathode for directing emissions from emitters. The focusing structure is commonly formed using Polyimide.
- 10 The faceplate of a field emission cathode ray tube requires a conductive anode electrode to carry the current used to illuminate the display. Conventional internal structures within the flat panel display include a support structure. Over time, repeated electron bombardment causes the electrical
- 15 characteristics of the support structure to vary over time. More particularly, the resistance of the support structure changes over time, resulting in spatially nonuniform resistivity. This deleteriously effects the visible image produced. More particularly, spatially nonuniform resistivity
- 20 causes the deflection of an electron beam either towards or away from the support structure. This produces regions within the visible display that are not properly illuminated. When walls are used as support structures, the deflection of electrons causes visible lines that extend across the visible display.
- 25 Also, spatially nonuniform resistivity can result in arcing.

Thus, a need exists for a flat panel display that does not produce regions of the visible display that are not properly illuminated as the electrical characteristics of internal components degrade over time. More particularly, a need exists
5 for internal components that do not have varying resistivity over time and that do not produce spatially nonuniform resistivity.

SUMMARY OF THE INVENTION

The present invention provides internal components that do not produce regions of the visible display that are not properly illuminated as internal components degrade over time. This is
5 accomplished by using internal components that do not have varying resistivity over time and that do not produce spatially nonuniform resistivity. The present invention provides internal components and methods for dry cleaning internal components so as to meet both of the above needs.

10

Specifically, in one embodiment, the present invention is comprised of a matrix structure that is adapted to be coupled to a faceplate of a flat panel display. The matrix structure is located on the faceplate so as to separate adjacent sub-pixel
15 regions. The present invention also includes a support structure and a focus structure. The matrix structure and the support structure are internal components of the flat panel display that are disposed between the faceplate and the backplate.

20

The internal components (e.g. the matrix structure, the focus structure and the support structure) are cleaned using a dry cleaning treatment. In one embodiment, the dry cleaning treatment uses an oxygen plasma. Alternatively, a hydrogen
25 plasma or an argon plasma is used. In yet another embodiment, an ozone that is applied in a UV radiation environment is used.

By cleaning the internal components with a dry cleaning treatment, resistivity in the support structure does not vary over time, preventing spatially nonuniform resistivity from developing. Hence, the present invention achieves electrical
5 stability by providing a support structure that has electrical characteristics that do not change over time, which reduces the possibility of arcing and regions of the visible display that are not properly illuminated.

10 These and other objects and advantages of the present invention will no doubt become obvious to those of ordinary skill in the art after having read the following detailed description of the preferred embodiments that are illustrated in the various drawing figures.

BRIEF DESCRIPTION OF THE DRAWINGS

The accompanying drawings, which are incorporated in and form a part of this specification, illustrate embodiments of the invention and, together with the description, serve to explain
5 the principles of the invention:

FIGURE 1 is a perspective view of a faceplate of a flat panel display device having a matrix structure disposed thereon in accordance with one embodiment of the present claimed
10 invention.

FIGURE 2 is a perspective view of a flat panel display device showing a support structure that is to be cleaned using a dry cleaning treatment in accordance with one embodiment of the
15 present claimed invention.

FIGURE 3 is a diagram showing a method for forming a matrix structure that is cleaned using a dry cleaning treatment in accordance with one embodiment of the present claimed invention.
20

FIGURE 4 is a side sectional view of the faceplate and matrix structure of FIGURE 1 taken along line A-A wherein the matrix structure is cleaned using a dry cleaning treatment in accordance with one embodiment of the present claimed invention.
25

FIGURE 5 is a diagram showing a method for forming a support structure that is cleaned using a dry cleaning treatment

in accordance with one embodiment of the present claimed invention.

FIGURE 6 is a side sectional view of the structure of
5 FIGURE 2 taken along line B-B wherein the support structure is cleaned using a dry cleaning treatment in accordance with one embodiment of the present claimed invention.

FIGURE 7 is a diagram showing a method for forming a
10 focusing structure that is cleaned using a dry cleaning treatment in accordance with one embodiment of the present claimed invention.

FIGURE 8 is a side sectional view of a focus structure of a
15 flat panel display device showing the use of a dry cleaning treatment to clean the focusing structure in accordance with one embodiment of the present claimed invention.

The drawings referred to in this description should be
20 understood as not being drawn to scale except if specifically noted.

DESCRIPTION OF THE PREFERRED EMBODIMENTS

Reference will now be made in detail to the preferred embodiments of the invention, examples of which are illustrated in the accompanying drawings. While the invention will be
5 described in conjunction with the preferred embodiments, it will be understood that they are not intended to limit the invention to these embodiments. On the contrary, the invention is intended to cover alternatives, modifications and equivalents, which may be included within the spirit and scope of the
10 invention as defined by the appended claims. Furthermore, in the following detailed description of the present invention, numerous specific details are set forth in order to provide a thorough understanding of the present invention. However, it will be obvious to one of ordinary skill in the art that the
15 present invention may be practiced without these specific details. In other instances, well known methods, procedures, and components have not been described in detail so as not to unnecessarily obscure aspects of the present invention.

20 Figure 1 shows a perspective view of a faceplate 100 of a flat panel display device having a matrix structure 102 coupled thereto. In the embodiment of Figure 1, matrix structure 102 is located on faceplate 100 such that the rows and columns of matrix structure 102 separate adjacent sub-pixel regions,
25 typically shown as 104. Additionally, in the present embodiment, matrix structure 102 is formed of Polyimide material. Although matrix structure 102 is formed of Polyimide

material in the present embodiment, the present invention is also well suited to use with various other matrix forming materials that may cause deleterious contamination. As an example, the present invention is also well suited for use with
5 a matrix structure that is comprised of a photosensitive Polyimide formulation containing components other than Polyimide.

With reference still to Figure 1, matrix structure 102 is a
10 "multi-level" matrix structure. That is, the rows of matrix structure 102 have a different height than the columns of matrix structure 102. The present invention is, however, well suited to use with a matrix structure that is not multi-level. Although the matrix structure of the present invention is
15 sometimes referred to as a black matrix, it will be understood that the term "black" refers to the opaque characteristic of the matrix structure. That is, the present invention is also well suited to having a color other than black. Furthermore, in the following Figures, only a portion of the interior surface of a
20 faceplate is shown for purposes of clarity. Additionally, the following discussion specifically refers to a matrix structure 102 that is cleaned using a dry cleaning treatment. Although such a specific recitation is found below, the present invention is also well suited for use with various other internal
25 components of a flat panel display device. Also, although some embodiments of the present invention refer to a matrix structure for defining pixel and/or sub-pixel regions of the flat panel

display, the present invention is also well suited to an embodiment in which the pixel/sub-pixel defining structure is not a "matrix" structure. Therefore, for purposes of the present application, the term matrix structure refers to a pixel
5 and/or sub-pixel defining structure and not to a particular physical shape of the structure.

Referring now to Figure 2, support structure 150 is shown to be disposed over matrix structure 102 in accordance with one
10 embodiment of the present claimed invention. As will be described below, in the present embodiment, support structure 150 is cleaned using a dry cleaning treatment. That is, the dry cleaning treatment cleans the surfaces of support structure 150. This produces a support structure 150 that has electrical
15 characteristics that will not degrade over time, giving uniform resistance and preventing spatially nonuniform resistivity on support structure 150.

Continuing with Figure 2, the present invention is well
20 suited for use with other types of support structures. Thus, the present invention is also well suited to an embodiment in which the support structure is comprised of, for example, pins, balls, columns, or various other shapes of supporting structures. Also, the present invention is well adapted for use
25 with supporting structures that are made of material other than ceramic. In particular, the present invention is compatible for

use with a support structure that contains conductive elements such as, for example, metal lines, conductive strips, etc.

Referring now to Figure 3, a method for forming a matrix structure is shown. First, as shown by block 401, a matrix structure is provided. This matrix structure is then exposed to a dry cleaning treatment as shown by step 402. In one embodiment, the dry cleaning treatment consists of the application of ozone in an Ultraviolet (UV) radiation environment. In one embodiment, a conventional Chemical Vapor Deposition (CVD) chamber is used to apply the dry cleaning treatment. In one embodiment, the dry cleaning treatment uses a UV laser beam to decompose liquid or solid organic material into gaseous products which can be removed as a vapor. A pulsed laser beam can be used to remove small particulate matter by a photo acoustic process.

Continuing with Figure 3, upon the application of dry cleaning treatment as shown by step 402, residual contaminants are removed from the surfaces of the matrix structure. These contaminants include carbon and carbon containing compounds.

With reference now to Figure 4, a side sectional view of faceplate 100 and matrix structure 102 is shown. In the side sectional view, only a portion of matrix structure 102 is shown for purposes of clarity. It will be understood, however, that the above-described steps are performed over much larger

portions of matrix structure 102 and are not limited only to those portion of matrix structure 102 shown in Figure 4.

Additionally, the above-described steps used in the formation of the present invention are also well suited to an approach in which a preliminary bake-out step is used to initially purge some of the contaminants from the matrix. In a bake-out step, the matrix structure 102 is heated prior to placing the matrix structure 102 in the sealed vacuum environment of the flat panel display.

10

Referring again to Figure 4, when a dry cleaning treatment such as dry cleaning treatment 402 of Figure 3 is applied to matrix structure 102, contaminants such as contaminant 500 are removed from the surface of matrix structure 102 as shown by arrow 501. The removal of contaminant 500 from the surface of matrix structure 102 provides a matrix structure 102 that has significantly reduced surface contaminant levels. This prevents contaminants such as contaminant 500 from being removed from matrix structure and deposited elsewhere. Thus, contaminant 500 will not deleteriously affect the display produced. That is, by cleaning matrix structure 102, contaminants are removed that can deleteriously affect the performance of the display when the contaminants leave the matrix structure.

25

Referring now to Figure 5, a method for forming a support structure that has electrical characteristics that do not degrade over time is shown. First, a support structure is

provided as shown by step 601. The support structure may be a support structure such as support structure 150 shown in Figure 2.

5 Continuing with Figure 5, as shown by step 602, a dry cleaning treatment is performed so as to clean the support structure. In one embodiment, the dry cleaning treatment consists of a plasma treatment such as the application of an oxygen plasma. Alternatively, a hydrogen plasma or an argon
10 plasma is used. In one embodiment, the dry cleaning treatment is applied using a RF Plasma Etcher. Alternatively, a conventional Chemical Vapor Deposition (CVD) chamber is used to apply the dry cleaning treatment. In one embodiment, the dry cleaning treatment consists of the application of ozone in a
15 Ultra Violet (UV) radiation environment. When a plasma treatment is used, the support structure is cleaned before it is deposited over the faceplate. This prevents possible damage to the faceplate from the plasma treatment. However, alternatively, the support structure may be cleaned after it is deposited over
20 the faceplate when the dry cleaning treatment consists of the application of ozone in a UV radiation environment. In one embodiment, the dry cleaning treatment uses a UV laser beam to decompose liquid or solid organic material into gaseous products which can be removed as a vapor. A pulsed laser beam can be
25 used to remove small particulate matter by a photo acoustic process.

Referring now to Figure 6, when a dry cleaning treatment such as dry cleaning treatment shown in step 602 of Figure 5 is applied to support structure 150, contaminants such as contaminant 700 which is located on the surface of support structure 150 are removed as shown by arrow 701. The removal of contaminants such as contaminant 700 from the surface of support structure 150 provides a support structure 150 that has significantly reduced surface contaminant levels. This produces a support structure 150 that has electrical characteristics that will not degrade over time, giving uniform resistance and preventing spatially nonuniform resistivity on support structure 150.

Though the dry cleaning treatment of matrix structure 102 and the dry cleaning treatment of support structure 150 is described as separate steps, matrix structure 102 and support structure 150 may be cleaned using a single dry cleaning treatment step. However, plasma cleaning may damage the active areas of the faceplate. Therefore, when both the support structure and the matrix structure are to be cleaned together, the dry cleaning treatment may consist of the application of ozone in a Ultra Violet (UV) radiation environment. Depending on the manufacturing criteria for making a particular display assembly, it may be more efficient and more cost effective to clean both matrix structure 102 and support structure 150 in a single dry cleaning treatment step.

Referring now to Figures 7-8, in one embodiment of the present invention, the physical components of a flat panel display include a focusing structure that is cleaned using a dry cleaning treatment. Referring now to Figure 7, a focusing
5 structure is provided as shown by step 801. Figure 8 shows a cross sectional view of focusing structure 160 that is disposed over a backplate 180.

Continuing with Figure 7, as shown by step 802, a dry
10 cleaning treatment is performed so as to clean the focusing structure. In one embodiment, the dry cleaning treatment consists of the application of an oxygen plasma. Alternatively, a hydrogen plasma or an argon plasma is used. In one
15 embodiment, the dry cleaning treatment is applied using an RF Plasma Etcher. Alternatively, a conventional Chemical Vapor Deposition (CVD) chamber is used. In one embodiment, the dry cleaning treatment consists of the application of ozone in a Ultra Violet (UV) radiation environment. In one embodiment, the
20 dry cleaning treatment uses a UV laser beam to decompose liquid or solid organic material into gaseous products which can be removed as a vapor. A pulsed laser beam can be used to remove small particulate matter by a photo acoustic process.

Referring now to Figure 8, a focusing structure 160 is
25 shown to be formed over backplate 180. Focusing structure 160 is operable to focus emissions from emitters 170. When a dry cleaning treatment such as dry cleaning treatment shown in step

802 of Figure 7 is applied to focus structure 160, contaminants such as contaminant 900 are removed from the surface of focusing structure 160 as shown by arrow 901.

5 Though the present invention is described with reference to specific internal components that are sealed between the faceplate and the backplate of a flat panel display (e.g. a matrix structure, a focusing structure and a support structure), the present invention is also well adapted for use with any
10 internal component of a flat panel display that is subjected to electron bombardment. The present invention is also applicable with various other matrix forming materials, focusing structure forming materials and support structure forming materials that may cause degraded electrical characteristics over time
15 resulting from electron bombardment.

 With reference to Figure 1-8, while the exact mechanism that produces internal components, and in particular, a support structure that has electrical characteristics that will not
20 degrade over time of the present invention is not known for sure, these results are probably a result of locally reduced oxygen levels in internal components. The support structure contains oxygen that is typically present in the form of oxides such as, for example, aluminum oxide, chromium oxide, and
25 titanium oxide. The oxygen reacts with contaminants located on the surfaces of prior art support structures. These contaminants include carbon and carbon compounds that react with

oxygen in the prior art structure so as to produce product compounds. These product compounds may include carbon monoxide and/or carbon dioxide gas.

5 As discussed above, the reasons that the dry cleaning processes of the present invention produces a support structure that has electrical characteristics that do not degrade over time is not known for sure. However, it is thought that the removal of oxygen affects the resistivity of the support
10 structure and allows spatially nonuniform resistivity to form over time. By removing contaminants on the surface, it is believed that this removal of oxygen is significantly reduced. However, any of a number of other different reactions and processes may be responsible for the desirable result obtained
15 by exposing the support structure to a dry cleaning process.

 Thus, the present invention provides internal components that have electrical characteristics that do not degrade over time. Because the electrical characteristics of the internal
20 components of the present invention is maintained, the present embodiment provides internal components that have uniform resistance and that do not produce spatially nonuniform resistivity. This prevents regions of the visible display that are not properly illuminated and decreases the chances that any
25 electrical arcing will occur.

The foregoing descriptions of specific embodiments of the present invention have been presented for purposes of illustration and description. They are not intended to be exhaustive or to limit the invention to the precise forms disclosed, and obviously many modifications and variations are possible in light of the above teaching. The embodiments were chosen and described in order best to explain the principles of the invention and its practical application, to thereby enable others skilled in the art best to utilize the invention and various embodiments with various modifications suited to the particular use contemplated. It is intended that the scope of the invention be defined by the Claims appended hereto and their equivalents.

Claims

1. A flat panel display device comprising:
 - a) a faceplate;
 - b) a backplate coupled to said faceplate; and
 - c) an internal component disposed between said faceplate and said backplate, said internal component having been treated using a dry cleaning treatment to remove contaminants therefrom.
2. The flat panel display device of Claim 1 wherein said internal component is a matrix structure.
3. The flat panel display device of Claim 1 wherein said internal component is a support structure.
4. The flat panel display device of Claim 1 wherein said internal component is a focus structure.
5. The flat panel display device of Claim 2 wherein said internal component is comprised of Polyimide.
6. The flat panel display device of Claim 3 wherein said internal component is comprised of ceramic.
7. The flat panel display device of Claim 3 wherein said dry cleaning treatment further comprises the application of oxygen plasma.
8. The flat panel display device of Claim 3 wherein said dry cleaning treatment further

comprises the application of hydrogen plasma.

9. The flat panel display device of Claim 3 wherein said dry cleaning treatment further comprises the application of argon plasma.

10. The flat panel display device of Claim 1 wherein said dry cleaning treatment further comprises the application of ozone in an ultraviolet radiation environment.

11. The flat panel display device of Claim 1 wherein said dry cleaning treatment further comprises the application of an ultraviolet laser beam.

12. The flat panel display device of Claim 11 wherein said dry cleaning treatment further comprises the application of a pulsed laser beam.

13. A method for cleaning an internal component of a flat panel display device, said method comprising exposing said internal component to a dry cleaning treatment, said dry cleaning treatment removing contaminants from the surface of said internal component.

14. The method of Claim 13 further comprising the step of providing an internal component having a surface, said internal component adapted to be disposed between a faceplate and a backplate of a flat panel display.

15. The method of Claim 13 or 14 wherein said internal component is a support structure.

16. The method of Claim 13 or 14 wherein said internal component is a matrix structure.

17. The method of Claim 16 wherein said internal component is comprised of Polyimide.

18. The method of Claim 15 wherein said internal component is comprised of a ceramic.
19. The method of Claim 13 wherein said exposing step further comprises exposing said internal component to oxygen plasma.
20. The method of Claim 13 wherein said exposing step further comprises exposing said internal component to hydrogen plasma.
21. The method of Claim 13 wherein said exposing step further comprises exposing said internal component to argon plasma.
22. The method of Claim 13 wherein said exposing step further comprises exposing said internal component to ozone in an ultraviolet radiation environment.
23. The method of Claim 13 wherein said exposing step further comprises the application of an ultraviolet laser beam.
24. The method of any one of the preceding claims, wherein said method prevents the existence of regions of a visible display that are not properly illuminated.
25. The method of Claim 16 further comprising the step of exposing said matrix structure to a dry cleaning treatment so as to remove contaminants disposed on the surfaces of said matrix structure.
26. The method of Claim 16 or 25 wherein said flat panel display includes a focus structure, said method further including:
 - exposing said focus structure to a dry cleaning treatment so as to remove contaminants disposed on the surfaces of said focus structure.

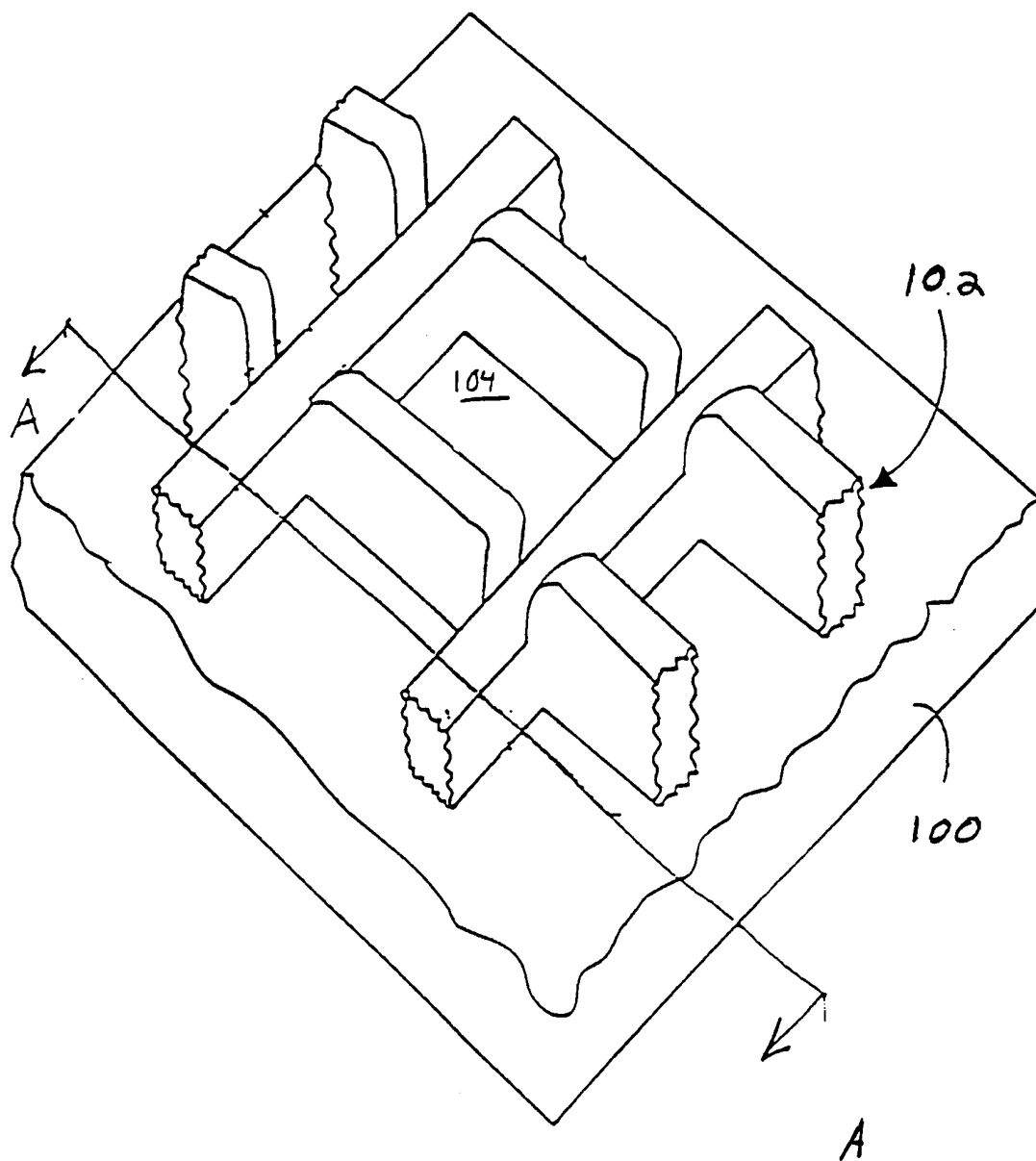


FIG.1

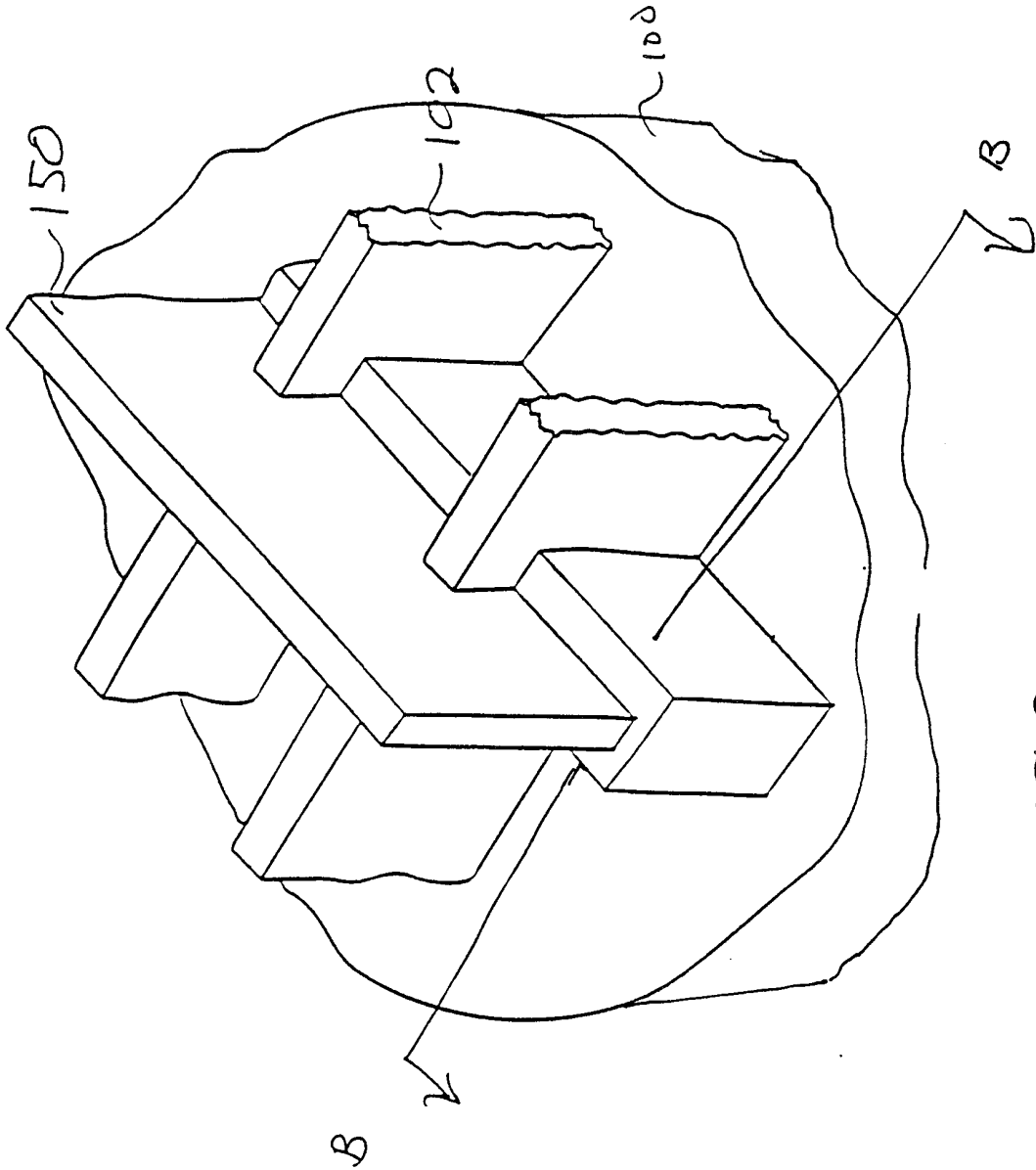


FIG. 2

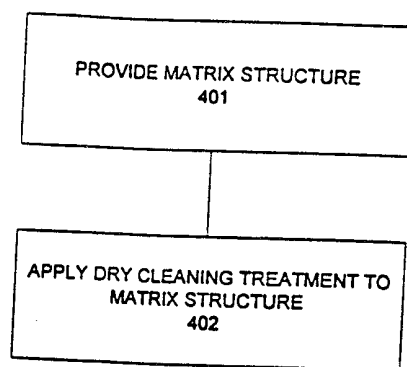


FIG. 3

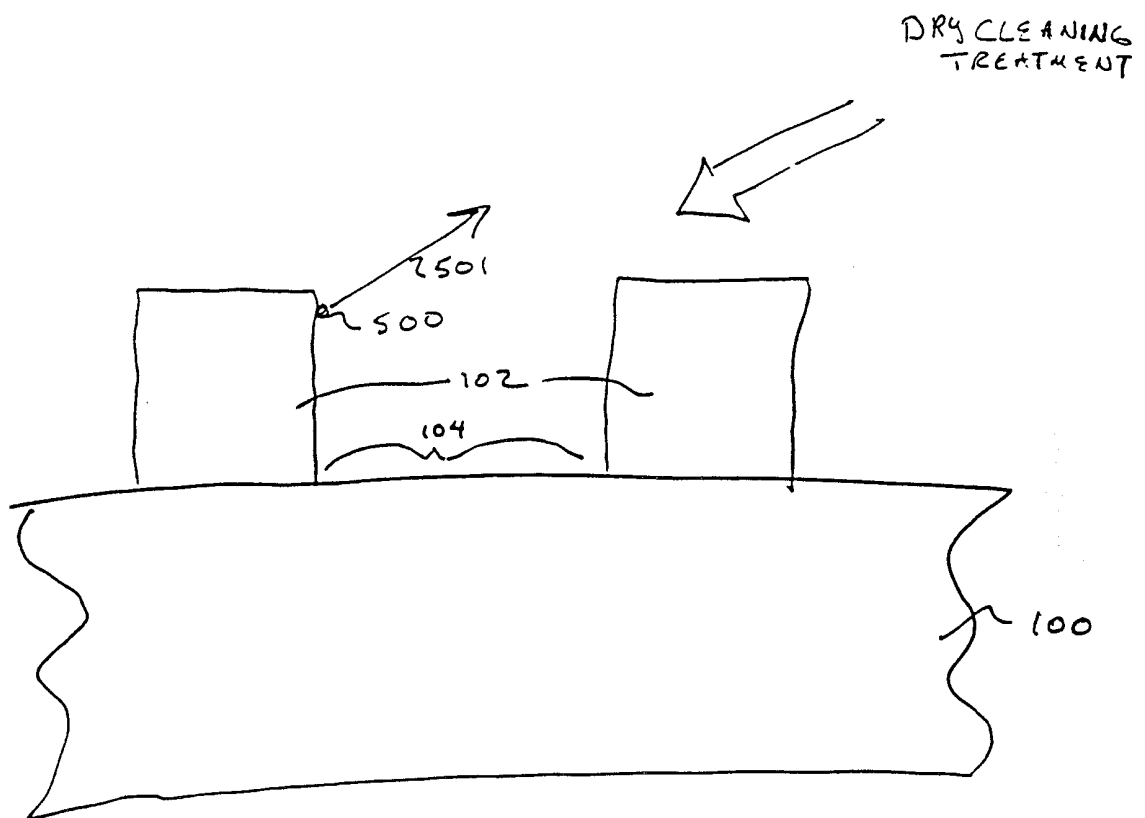


FIG.4

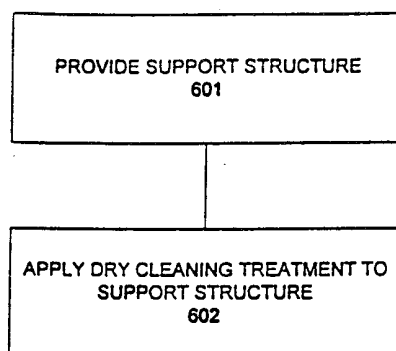


FIG. 5



FIG.6

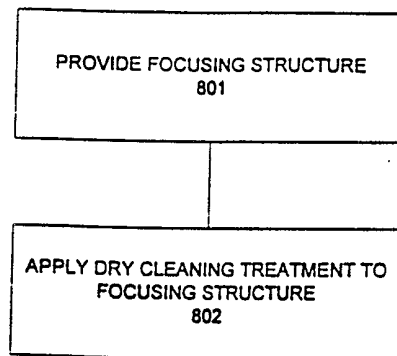


FIG. 7

APPLY
DRY CLEANING
TREATMENT

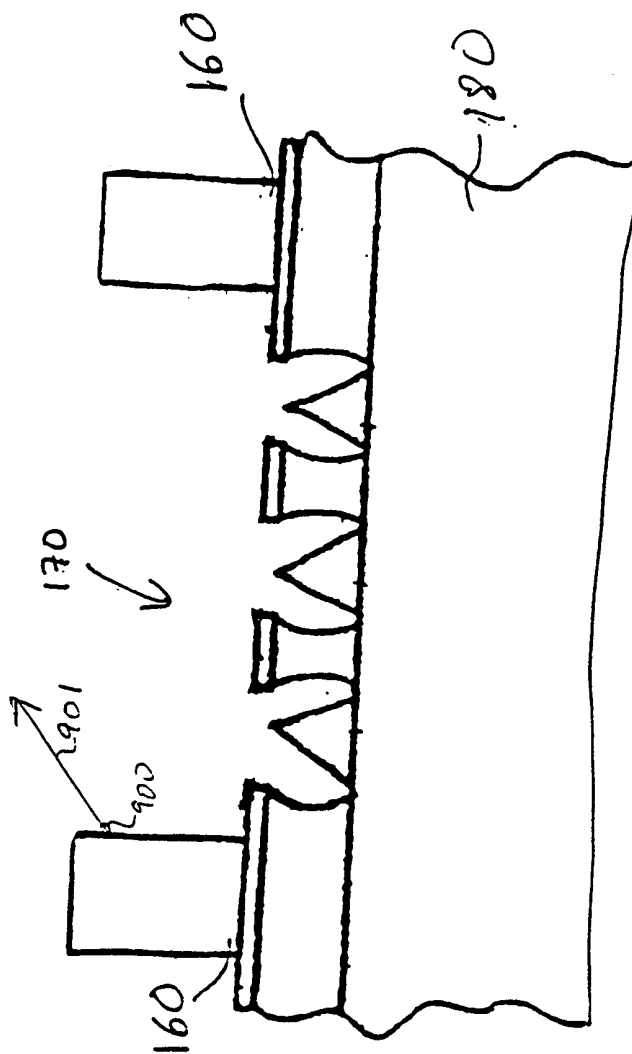


FIG 8

INTERNATIONAL SEARCH REPORT

International application No.
PCT/US99/10302

A. CLASSIFICATION OF SUBJECT MATTER

IPC(6) :H01J 1/88

US CL :313/292, 422, 495

According to International Patent Classification (IPC) or to both national classification and IPC

B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)

U.S. : 313/292, 422, 495

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched
NoneElectronic data base consulted during the international search (name of data base and, where practicable, search terms used)
None

C. DOCUMENTS CONSIDERED TO BE RELEVANT

Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
X,P	US 5,883,467 A (CHALAMALA ET AL) 16 March 1999 (16-03-99), Figure 1 and Line 32 of Column 1.	1-26



Further documents are listed in the continuation of Box C.



See patent family annex.

* Special categories of cited documents:	
A document defining the general state of the art which is not considered to be of particular relevance	*T* later document published after the international filing date or priority date and not in conflict with the application but cited to understand the principle or theory underlying the invention
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Date of the actual completion of the international search

21 JULY 1999

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11 AUG 1999

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